4V Drive Nch MOS FET RSS070N05

●Structure

Silicon N-channel MOS FET

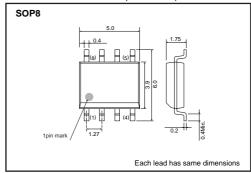
Features

- 1) Built-in G-S Protection Diode.
- 2) Small Surface Mount Package (SOP8).

Applications

Power switching, DC / DC converter, Inverter

●External dimensions (Unit : mm)



Packaging dimensions

	Package	Taping		
Type	Code	TB		
	Basic ordering unit (pieces)	2500		
RSS070N08	0			

● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V _{DSS}	45	V	
Gate-source voltage	V_{GSS}	20	V	
Drain current	Continuous	I_D	±7.0	Α
	Pulsed	I_{DP} *1	±28	Α
Source current	Continuous	I _S	1.6	Α
(Body diode)	Pulsed	I_{SP} *1	28	Α
Total power dissipation	P_D *2	2	W	
Chanel temperature	T_ch	150	°C	
Range of Storage temp	T_{stg}	-55 to +150	°C	

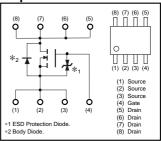
^{*1} PW≤10μs, Duty cycle≤1%

Thermal resistance

Parameter	Symbol	Limits	Unit
Chanel to ambient	R _{th(ch-a)} *	62.5	°C/W

^{*} Mounted on a ceramic board

●Equivalent circuit



* A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use a protection circuit when the fixed voltage are exceeded.

^{*2} Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	10	μΑ	Vgs=20V, Vds=0V
Drain-source breakdown voltage	V(BR) DSS	45	_	_	V	ID= 1mA, VGS=0V
Zero gate voltage drain current	IDSS	_	_	1	μΑ	V _{DS} = 45V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	1.0	_	2.5	V	V _{DS} = 10V, I _D = 1mA
Static drain-source on-state resistance		_	18	25	mΩ	I _D =7A, V _{GS} = 10V
	R _{DS (on)} *	-	23	32	mΩ	I _D = 7A, V _{GS} = 4.5V
		-	25	35	mΩ	I _D = 7A, V _{GS} = 4.0V
Forward transfer admittance	Y _{fs} *	6.0	_	_	S	V _{DS} = 10V, I _D = 7A
Input capacitance	Ciss	-	1000	_	pF	V _{DS} = 10V
Output capacitance	Coss	-	230	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	_	125	_	pF	f=1MHz
Turn-on delay time	td (on) *	_	16	_	ns	V _{DD} ≒ 25V
Rise time	tr *	_	27	_	ns	In= 3.5A Vgs= 10V
Turn-off delay time	t _{d (off)} *	_	57	_	ns	VGS= 10V RL=7.1Ω
Fall time	t _f *	_	21	_	ns	R _G =10Ω
Total gate charge	Qg *	-	12.0	16.8	nC	V _{DD} ≒25V V _{GS} =5V
Gate-source charge	Q _{gs} *	-	3.0	_	nC	I _D = 7A
Gate-drain charge	Q _{gd} *	-	4.6	_	nC	R _L =3.6Ω R _G =10Ω

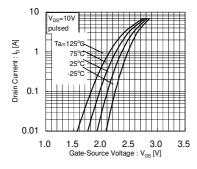
^{*}Pulsed

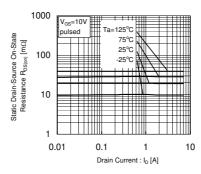
●Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	V _{SD} *	_	_	1.2	V	$I_S=1.6A/V_{GS}=0V$

^{*} pulsed

•Electrical characteristic curves





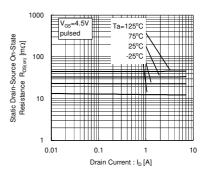
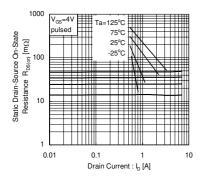
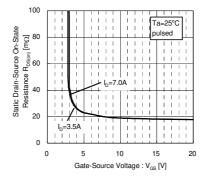


Fig.1 Typical Transfer Characteristics

Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (1)

Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (2)





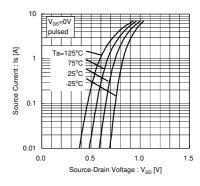
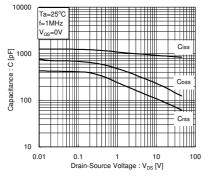
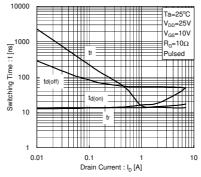


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (3)

Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

Fig.6 Source-Current vs. Source-Drain Voltage





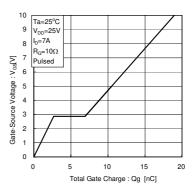


Fig.7 Typical capacitance vs. Source-Drain Voltage

Fig.8 Switching Characteristics

Fig.9 Dynamic Input Characteristics

Measurement circuits

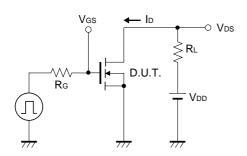


Fig.10 Switching Time Test Circuit

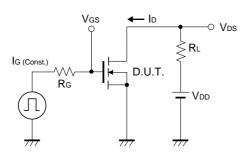


Fig.12 Gate Charge Test Circuit

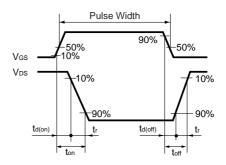


Fig.11 Switching Time Waveforms

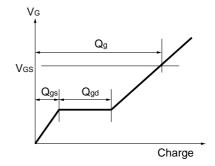


Fig.13 Gate Charge Waveform

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